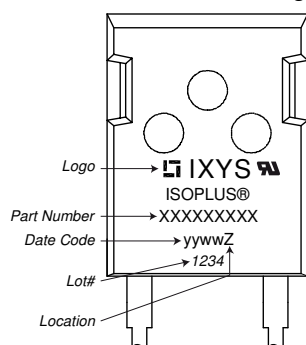


Fast Diode				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V _{RSM}	max. non-repetitive reverse blocking voltage	T _{VJ} = 25°C				600	V
V _{RRM}	max. repetitive reverse blocking voltage	T _{VJ} = 25°C				600	V
I _R	reverse current, drain current	V _R = 600 V	T _{VJ} = 25°C			250	μA
		V _R = 600 V	T _{VJ} = 150°C			2	mA
V _F	forward voltage drop	I _F = 30 A	T _{VJ} = 25°C			2.51	V
		I _F = 60 A				3.19	V
		I _F = 30 A	T _{VJ} = 150°C			1.61	V
		I _F = 60 A				2.24	V
I _{FAV}	average forward current	T _C = 110°C rectangular d = 0.5	T _{VJ} = 175°C			30	A
V _{F0}	threshold voltage	} for power loss calculation only		T _{VJ} = 175°C		0.84	V
r _F	slope resistance					19.6	mΩ
R _{thJC}	thermal resistance junction to case					1.1	K/W
R _{thCH}	thermal resistance case to heatsink				0.25		K/W
P _{tot}	total power dissipation	T _C = 25°C				135	W
I _{FSM}	max. forward surge current	t = 10 ms; (50 Hz), sine; V _R = 0 V		T _{VJ} = 45°C		250	A
C _J	junction capacitance	V _R = 400 V f = 1 MHz		T _{VJ} = 25°C		26	pF
I _{RM}	max. reverse recovery current	} I _F = 30 A; V _R = 300 V -di _F /dt = 200 A/μs		T _{VJ} = 25 °C		2.5	A
t _{rr}	reverse recovery time			T _{VJ} = 100 °C		4.5	A
				T _{VJ} = 25 °C		25	ns
				T _{VJ} = 100 °C		70	ns

Package ISOPLUS247				Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit	
I _{RMS}	RMS current	per terminal			70	A	
T _{VJ}	virtual junction temperature		-55		175	°C	
T _{op}	operation temperature		-55		150	°C	
T _{stg}	storage temperature		-55		150	°C	
Weight				6		g	
F _C	mounting force with clip		20		120	N	
d _{Spp/App}	creepage distance on surface striking distance through air	terminal to terminal	5.4			mm	
d _{Spb/Apb}		terminal to backside	4.1			mm	
V _{ISOL}	isolation voltage	t = 1 second	3600			V	
		t = 1 minute	3000			V	
		50/60 Hz, RMS; I _{ISOL} ≤ 1 mA					

Product Marking



Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DSEP30-06BR	DSEP30-06BR	Tube	30	480363

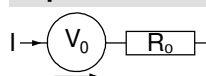
Similar Part	Package	Voltage class
DSEP30-06B	TO-247AD (2)	600
DSEP30-06A	TO-247AD (2)	600
DSEP29-06A	TO-220AC (2)	600
DSEP29-06AS	TO-263AB (D2Pak) (2)	600

DHG30I600HA	TO-247AD (2)	600
DHG30I600PA	TO-220AC (2)	600
DHG30IM600PC	TO-263AB (D2Pak) (2)	600

Equivalent Circuits for Simulation

* on die level

$T_{VJ} = 175^{\circ}\text{C}$



Fast Diode

$V_{0 \max}$ threshold voltage

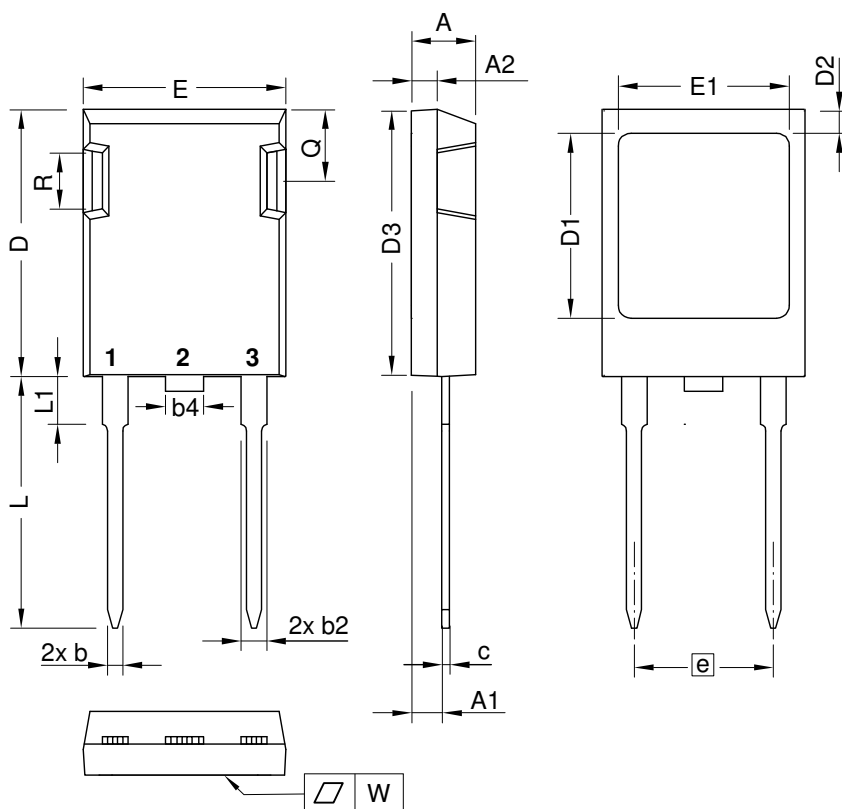
0.84

V

$R_{0 \max}$ slope resistance *

17

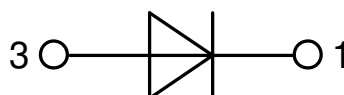
mΩ

Outlines ISOPLUS247


Dim.	Millimeter		Inches	
	min	max	min	max
A	4.83	5.21	0.190	0.205
A1	2.29	2.54	0.090	0.100
A2	1.91	2.16	0.075	0.085
b	1.14	1.40	0.045	0.055
b2	1.91	2.20	0.075	0.087
b4	2.92	3.24	0.115	0.128
c	0.61	0.83	0.024	0.033
D	20.80	21.34	0.819	0.840
D1	15.75	16.26	0.620	0.640
D2	1.65	2.15	0.065	0.085
D3	20.30	20.70	0.799	0.815
E	15.75	16.13	0.620	0.635
E1	13.21	13.72	0.520	0.540
e	10.90 BSC		0.429 BSC	
L	19.81	20.60	0.780	0.811
L1	3.81	4.38	0.150	0.172
Q	5.59	6.20	0.220	0.244
R	4.25	5.50	0.167	0.217
W	-	0.10	-	0.004

Die konvexe Form des Substrates ist typ. < 0.04 mm über der Kunststoffoberfläche der Bauteilunterseite
 The convex bow of substrate is typ. < 0.04 mm over plastic surface level of device bottom side

Die Gehäuseabmessungen entsprechen dem Typ TO-247 AD gemäß JEDEC außer Schraubloch und L_{max} .
 This drawing will meet all dimensions requirement of JEDEC outline TO-247 AD except screw hole and except L_{max} .



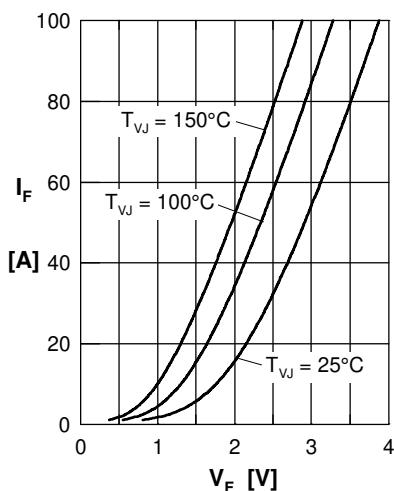
Fast Diode


Fig. 1 Forward current I_F versus V_F

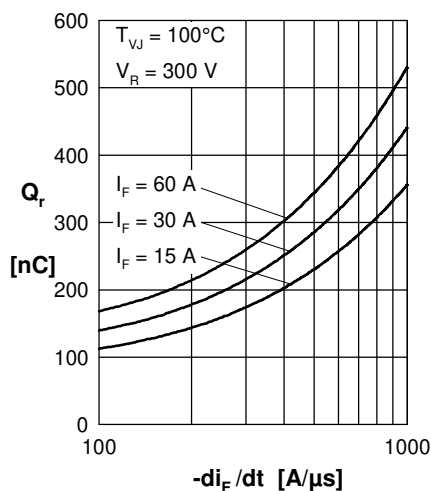


Fig. 2 Typ. reverse recov. charge Q_r versus $-di_F/dt$

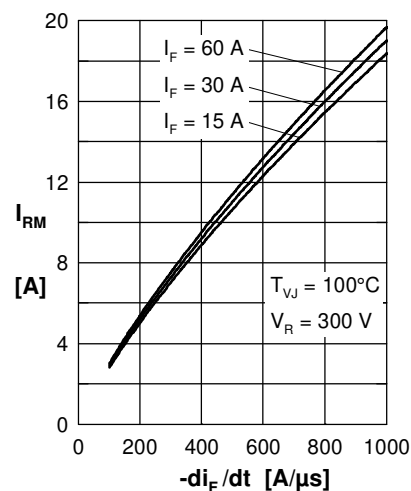


Fig. 3 Typ. peak reverse current I_{RM} versus $-di_F/dt$

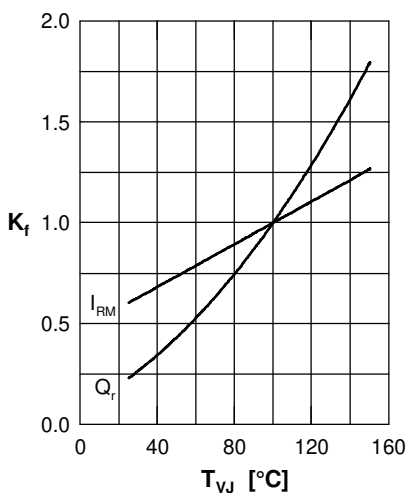


Fig. 4 Dynamic parameters Q_r , I_{RM} versus T_{VJ}

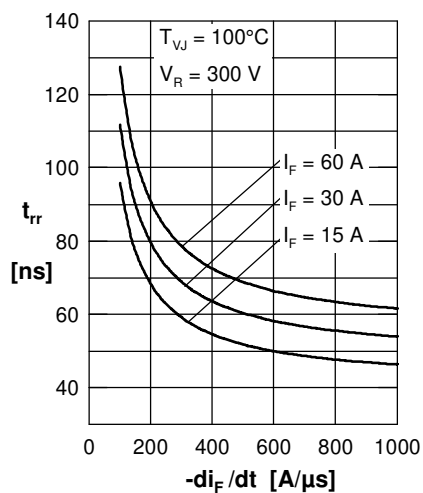


Fig. 5 Typ. recovery time t_{rr} versus $-di_F/dt$

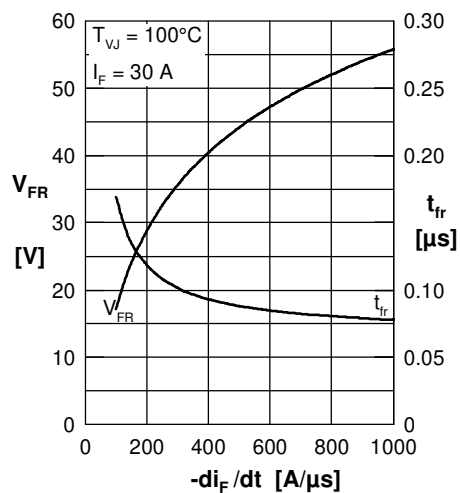


Fig. 6 Typ. peak forward voltage V_{FR} and t_{fr} versus di_F/dt

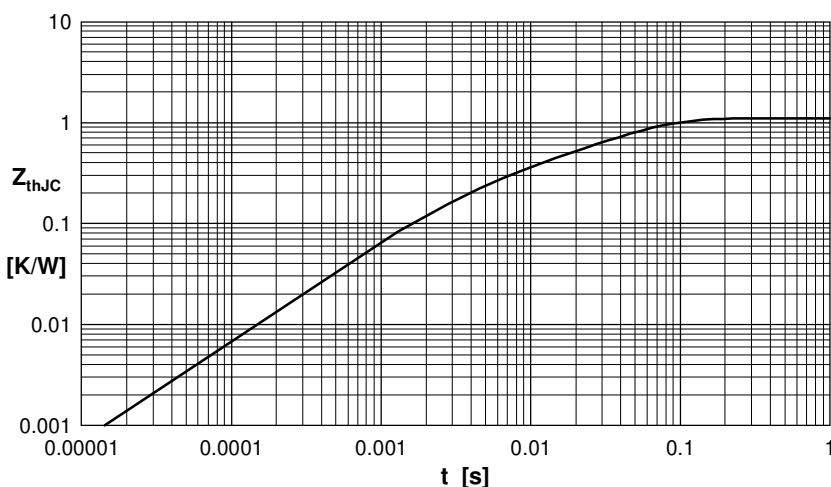


Fig. 7 Transient thermal impedance junction to case

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.030	0.0005
2	0.100	0.0050
3	0.360	0.0200
4	0.610	0.0500